

WP1384AD/ID

3.4mm Single-Level Circuit Board Indicator



DESCRIPTION

• The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode

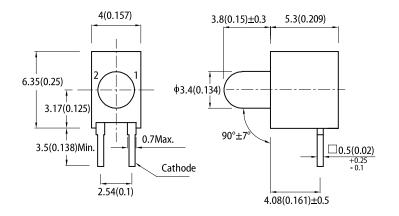
FEATURES

- · Ideal for card edge status indication
- High reliability-life measured in years
- Housing UL rating: 94V-0
- · Housing material: Type 66 nylon
- Halogen-free
- RoHS compliant

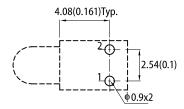
APPLICATIONS

- Status indicator
- Illuminator
- Signage applications
- · Decorative and entertainment lighting
- · Commercial and residential architectural lighting

PACKAGE DIMENSIONS



Recommended PCB Layout



Notes:

Notes: 1. All dimensions are in millimeters (inches). 2. Tolerance is ±0.25(0.01") unless otherwise noted. 3. Lead spacing is measured where the leads emerge from the package. 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice

SELECTION GUIDE

Part Number	Emitting Color	Lens Type	lv (mcd) @	2 10mA ^[2] Typ. 50	Viewing Angle ^[1]	
Fait Number	(Material)	Lens Type	Min.	Тур.	201/2	
WP1384AD/ID	WP1384AD/ID High Efficiency Red	Ded Diffused	20	50	- 60°	
WF 1304AD/ID	(GaAsP/GaP)	Red Diffused	*12	*30		

Notes

1, 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: +/-15%.
 * Luminous intensity value is traceable to CIE127-2007 standards.

Kingbright

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Querrahad	Emitting Color	Value		Unit
Parameter	Symbol	Emitting Color	Тур.	Typ. Max.	
Wavelength at Peak Emission $I_F = 10 \text{mA}$	λ_{peak}	High Efficiency Red	627	-	nm
Dominant Wavelength I _F = 10mA	λ_{dom} ^[1]	High Efficiency Red	617	-	nm
Spectral Bandwidth at 50% Φ REL MAX I_F = 10mA	Δλ	High Efficiency Red	45	-	nm
Forward Voltage I _F = 10mA	V _F ^[2]	High Efficiency Red	1.9	2.3	V
Reverse Current (V _R = 5V)	I _R	High Efficiency Red	-	10	μΑ
Temperature Coefficient of λ_{peak} I_F = 10mA, -10°C $\leq T \leq 85^\circ$ C	$TC_{\lambda peak}$	High Efficiency Red	0.13	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 10mA, -10°C $\leq T \leq 85^\circ$ C	TC _{λdom}	High Efficiency Red	0.06	-	nm/°C
Temperature Coefficient of V_F I_F = 10mA, -10°C $\leq T \leq 85^\circ C$	TCv	High Efficiency Red	-1.9	-	mV/°C

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

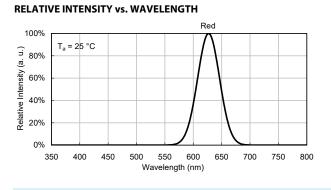
ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	P _D	75	mW	
Reverse Voltage	V _R	5	v	
Junction Temperature	Тј	125	°C	
Operating Temperature	T _{op}	-40 To +85	°C	
Storage Temperature	T _{stg}	-40 To +85	°C	
DC Forward Current	l _F	30	mA	
Peak Forward Current	I _{FP} ^[1]	160	mA	
Electrostatic Discharge Threshold (HBM)	-	8000	V	
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	640	°C/W	
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	430	°C/W	
Lead Solder Temperature ^[3]		260°C For 3 Seconds		
Lead Solder Temperature ^[4]		260°C For 5 Seconds		

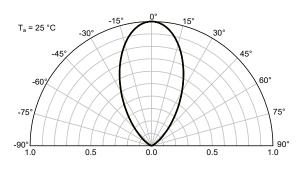
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{In JA}, R_{EN JA}, Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. 2mm below package base. 4. 5mm below package base. 5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

Kingbright

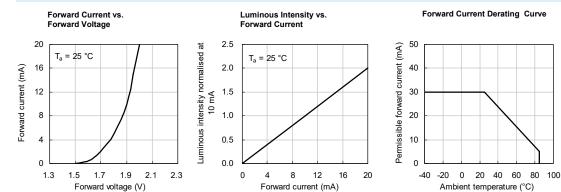
TECHNICAL DATA



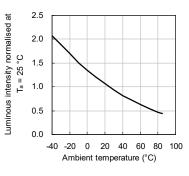
SPATIAL DISTRIBUTION



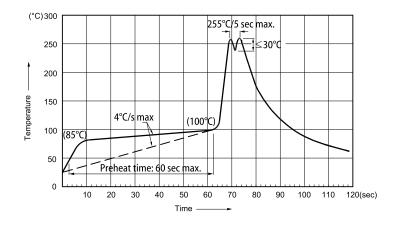
HIGH EFFICIENCY RED







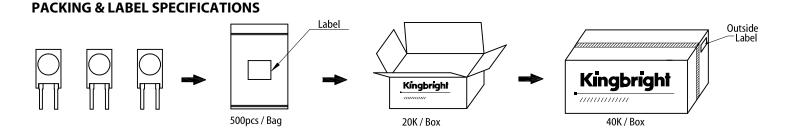
RECOMMENDED WAVE SOLDERING PROFILE



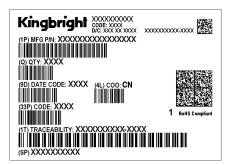
Notes

- Notes:
 1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
 3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
 4. Fixtures should not incur stress on the component when mounting and during soldering process.
 5. SAC 305 solder alloy is recommended.

- 6. No more than one wave soldering pass.



Kingbright



PRECAUTIONS

Storage Conditions

- 1. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
- 2. The LEDs should be stored at temperature <30°C and relative humidity <70%. If the packaging is opened but not used within three months, the unused LEDs should be stored in a sealed container with nitrogen atmosphere and moisture absorbent material.

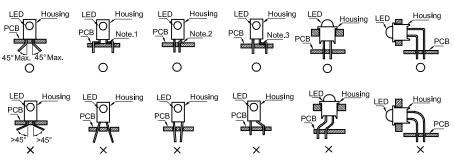
LED Mounting Method

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. Note 1-3: Do not route PCB trace in the contact area between the

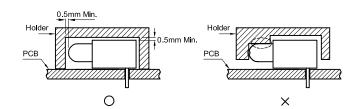
leadframe and the PCB to prevent short-circuits.

Lead Forming Procedures

- 1. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.
- 2. The tip of the soldering iron should never touch the lens epoxy.
- 3. Through-hole LEDs are incompatible with reflow soldering.
- 4. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.



" ○ " Correct mounting method " x " Incorrect mounting method



PRECAUTIONARY NOTES

- 2 The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3 When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- 4 liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance 5 The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright
- All design applications should refer to Kingbright application notes available at https://w

```
6
```

The information included in this document reflects representative usage scenarios and is intended for technical reference only